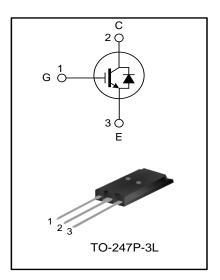
140A, 1200V FIELD STOP IGBT

DESCRIPTION

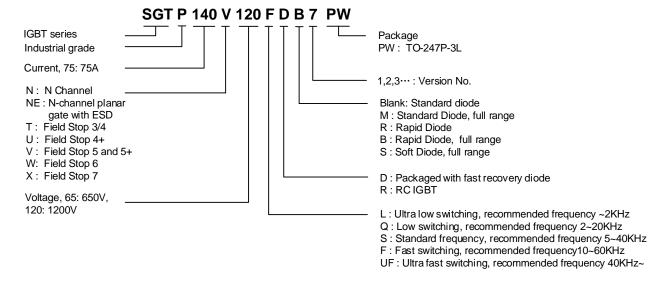
The SGTP140V120FDB7PW Field Stop IGBT adopts Silan Field Stop V technology, features low conduction loss and switching loss. This device is applicable to photovoltaic, UPS, SMPS, and PFC fields.

FEATURES

- 140A, 1200V, V_{CE(sat)(typ.)}=1.6V@I_C=140A
- Low conduction loss
- Ultra-fast switching
- High input impedance
- T_{Jmax.}=175°C



NOMENCLATURE



ORDERING INFORMATION

Part No.	Package	Marking	Marking Hazardous Substance Control	
SGTP140V120FDB7PW	TO-247P-3L	P140V120FDB7	Halogen free	Tube

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ABSOLUTE MAXIMUM RATINGS (UNLESS OTHERWISE NOTED, Tc=25°C)

Charact	eristics	Symbol	Ratings	Unit	
Collector to Emitter Voltage		V _{CE}	1200	V	
Gate to Emitter Volt	tage	V_{GE}	±20	V	
Transient Gate-Emi (t _p ≤10µs, D<0.010)	itter Voltage	V_{GE}	±30	٧	
Collector Current	T _C =25°C		175	А	
Collector Current	T _C =100°C	I _C	154		
Pulsed Collector Cu	urrent	I _{CM}	560	Α	
Diode Current	T _C =25°C		170	Α	
Diode Current	T _C =91°C	I _F	140	A	
Pulsed Diode Current		I _{FM}	560	Α	
Power Dissipation (T _C =25°C)		P _D	833	W	
Operating Junction Temperature		TJ	-40∼+175	°C	
Storage Temperatu	re Range	T _{stg}	-55∼+150	°C	

THERMAL CHARACTERISTICS

Characteristics	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Thermal Resistance, Junction to Case	Rejc				0.18	°C/W
(IGBT)	IXAJC				0.10	C/VV
Thermal Resistance, Junction to Case	D				0.30	°C ///
(FRD)	R _{eJC}				0.30	°C/W
Thermal Resistance, Junction to	В				40	0000
Ambient (IGBT)	$R_{\theta JA}$				40	°C/W
Soldering Temperature (in line)	T _{sold}	15 ⁺² -0 sec, 1time			260	°C

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ELECTRICAL CHARACTERISTICS OF IGBT (UNLESS OTHERWISE NOTED, Tc=25°C)

Characteristics	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Collector to Emitter Breakdown Voltage	BV _{CE}	V _{GE} =0V, I _C =1mA	1200			V
C-E Leakage Current	I _{CES}	V _{CE} =1200V, V _{GE} =0V			40	μA
G-E Leakage Current	I _{GES}	V _{GE} =20V, V _{CE} =0V			±100	nA
G-E Threshold Voltage	$V_{\text{GE(th)}}$	I _C =1mA, V _{CE} =V _{GE}	4.2	5.4	6.8	V
Collector to Emitter	\/	I _C =140A, V _{GE} =15V, T _C =25°C		1.6	2.4	V
Saturation Voltage	$V_{CE(sat)}$	I _C =140A, V _{GE} =15V, T _C =175°C		2.0		V
Input Capacitance	Cies	\/ 00\/		19007		
Output Capacitance	C _{oes}	V _{CE} =30V		354		F
Reverse Transfer Capacitance	C _{res}	V _{GE} =0V f=1MHz		97		pF
Turn-On Delay Time	T _{d(on)}			93		
Rise Time	T _r	V _{CE} =600V		72		
Turn-Off Delay Time	T _{d(off)}	I _C =140A		708		ns
Fall Time	T _f	$R_g=10\Omega$		75		
Turn-On Switching Loss	Eon	V _{GE} =15V		5.88		
Turn-Off Switching Loss	E _{off}	inductive load		6.99		mJ
Total Switching Loss	E _{st}			12.87		
Turn-On Delay Time	T _{d(on)}			88		
Rise Time	Tr	V _{CE} =600V		34		
Turn-Off Delay Time	T _{d(off)}	I _C =70A		735		ns
Fall Time	T _f	$R_g=10\Omega$		76		
Turn-On Switching Loss	Eon	V _{GE} =15V		2.46		
Turn-Off Switching Loss	E _{off}	inductive load		3.57		mJ
Total Switching Loss	E _{st}			6.03		
Total Gate Charge	Qg			908		
Gate to Emitter Charge	Q _{ge}	V _{CE} =600V, I _C =140A, V _{GE} =15V		118		nC
Gate to Collector Charge	Q_{gc}			382		

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ELECTRICAL CHARACTERISTICS OF FRD (UNLESS OTHERWISE NOTED, T_C=25°C)

Characteristics	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Diode Forward Voltage	V	I _F =140A, T _C =25°C		3.0	3.8	V
Diode Forward Vollage	V_{FM}	I _F =140A, T _C =175°C		2.4		V
Diode Reverse Recovery	т			131 3.3		ns µC
Time	T_{rr}					
Diode Reverse Recovery	0					
Charge	Q_{rr}	$V_R=600V$, $I_F=140A$, $R_g=10\Omega$,				
Diode Reverse Recovery	-	T _C =25°C		34		Α
Current	I _{rrm}			34		
Diode Reverse Recovery	F			1.46		mJ
Loss	E _{rec}			1.40		IIIJ

ELECTRICAL CHARACTERISTICS OF IGBT (UNLESS OTHERWISE NOTED, T_C=175°C)

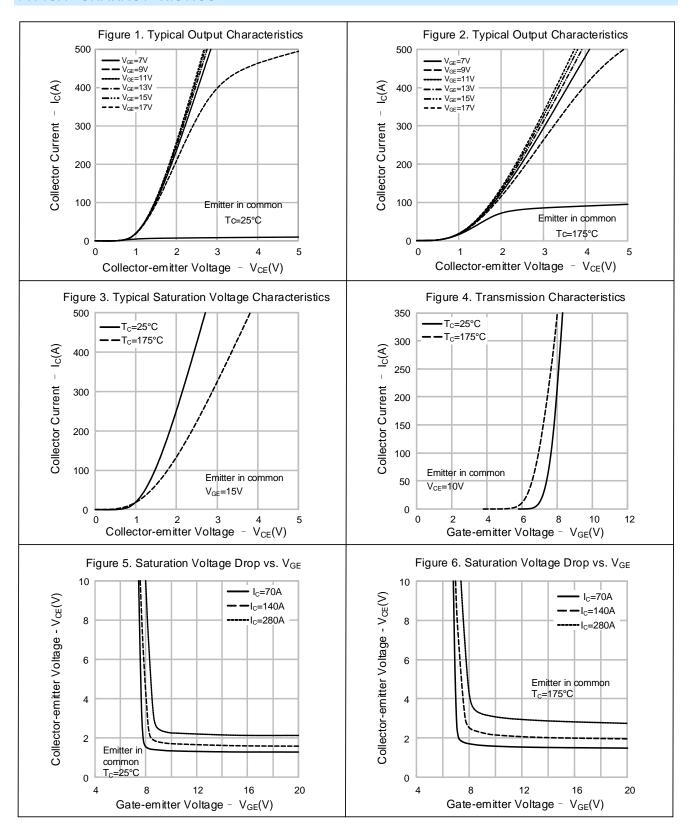
Characteristics	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Turn-On Delay Time	T _{d(on)}	.,		86		
Rise Time	T _r	V _{CE} =600V		72		20
Turn-Off Delay Time	$T_{d(off)}$	$I_{C}=140A$ $R_{q}=10\Omega$		782		ns
Fall Time	T _f	$V_{GE}=15V$		144		
Turn-On Switching Loss	E _{on}	inductive load		7.27		
Turn-Off Switching Loss	E _{off}	T _C =175°C		9.80		mJ
Total Switching Loss	E _{st}	16-173 0		17.07		
Turn-On Delay Time	T _{d(on)}	V 000V		79		
Rise Time	T _r	V _{CE} =600V		37		20
Turn-Off Delay Time	$T_{d(off)}$	I_{C} =70A R_{q} =10 Ω		814		ns
Fall Time	T _f	$V_{GE}=15V$		135		
Turn-On Switching Loss	Eon	inductive load		3.15		
Turn-Off Switching Loss	E _{off}	T _C =175°C		5.10		mJ
Total Switching Loss	E _{st}	10-1100		8.25		

ELECTRICAL CHARACTERISTICS OF FRD (UNLESS OTHERWISE NOTED, Tc=175°C)

Characteristics	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Diode Reverse Recovery	т			206		ns
Time	T _{rr}					
Diode Reverse Recovery	0			21.7		μC
Charge	Q _{rr}	V_R =600V, I_F =140A, R_g =10 Ω ,				
Diode Reverse Recovery		T _c =175°C		80		А
Current	I _{rrm}					
Diode Reverse Recovery	Г			F 24		m l
Loss	E _{rec}			5.34		mJ

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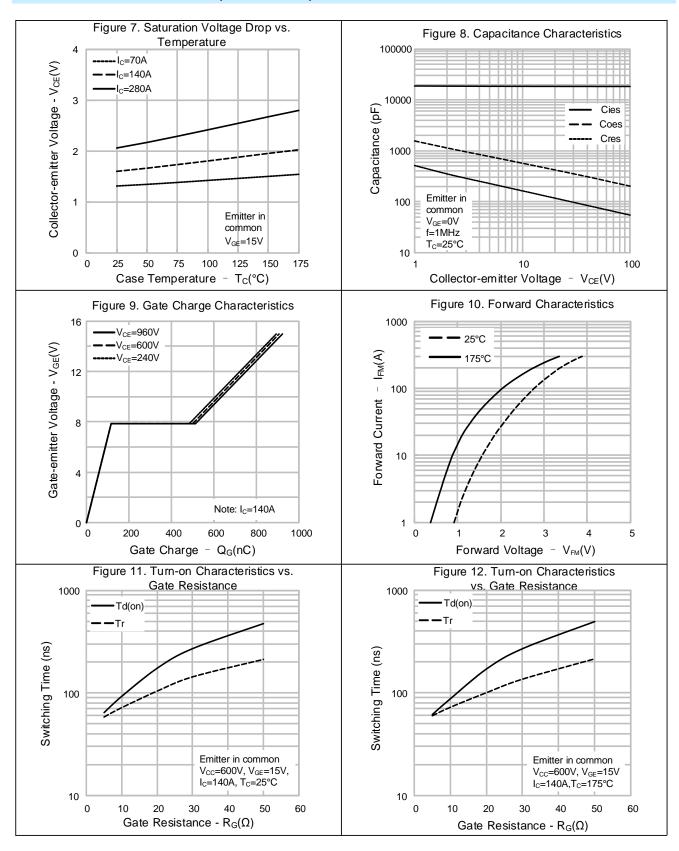
TYPICAL CHARACTERISTICS



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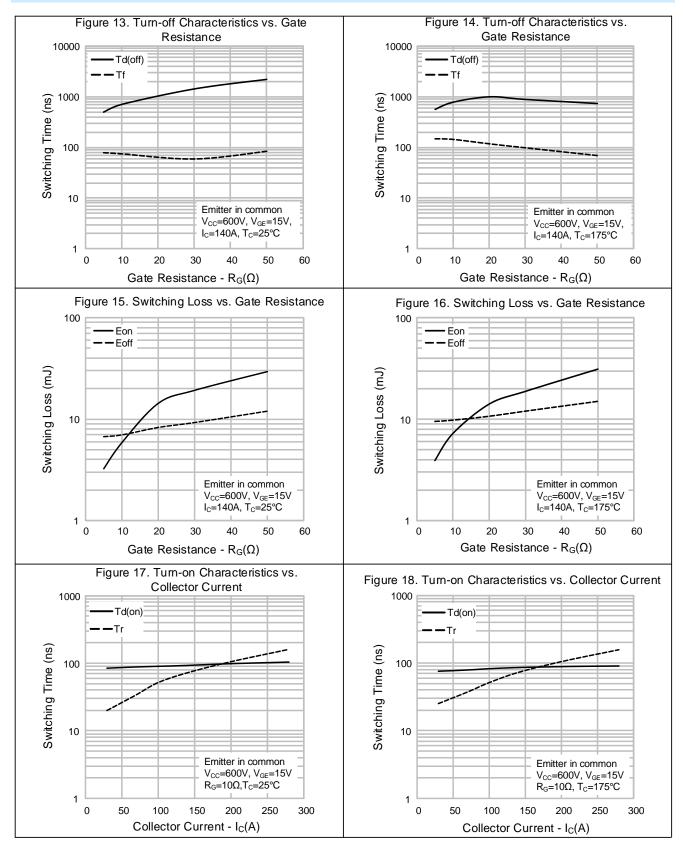
TYPICAL CHARACTERISTICS (CONTINUED)



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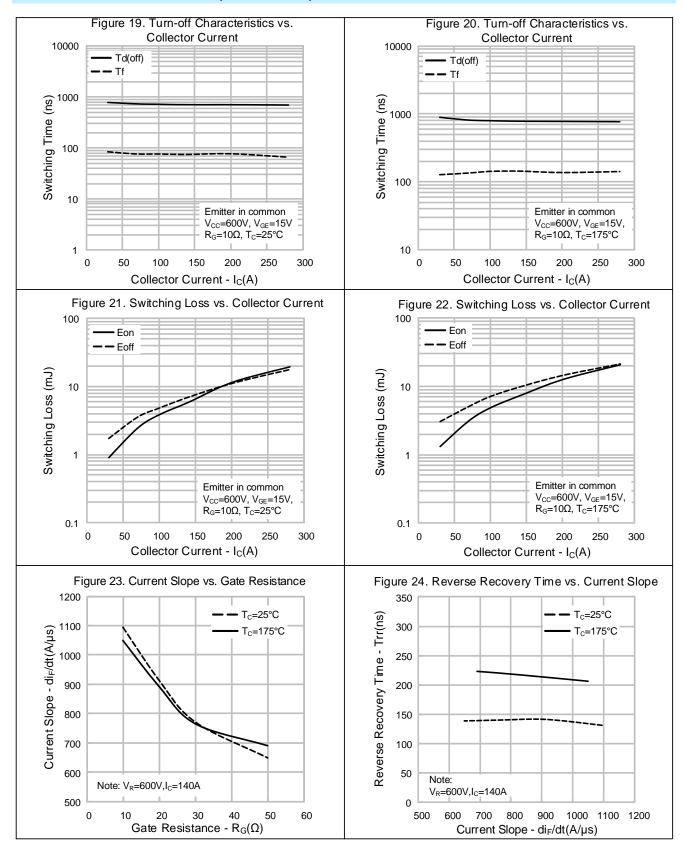
TYPICAL CHARACTERISTICS (CONTINUED)



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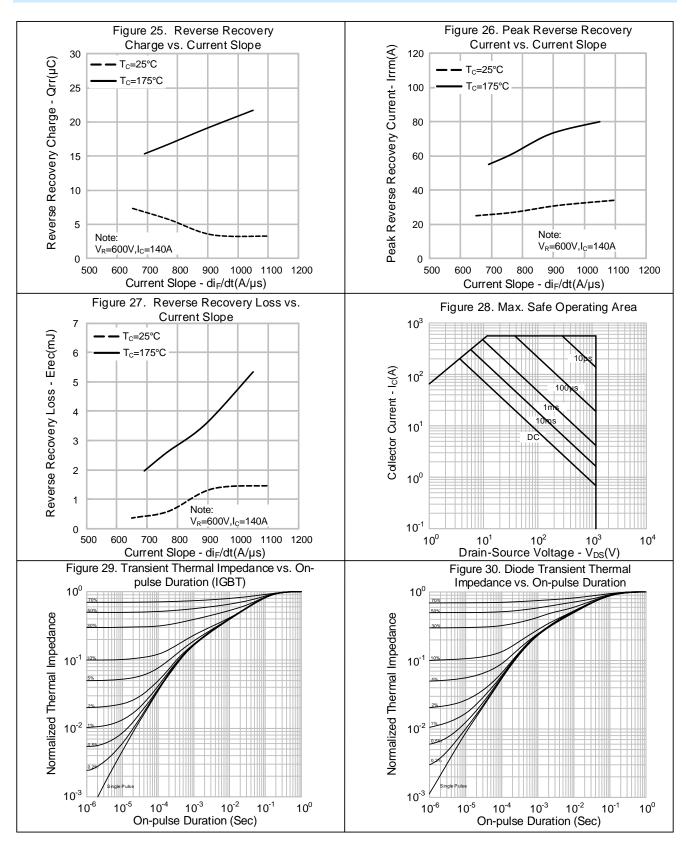


TYPICAL CHARACTERISTICS (CONTINUED)





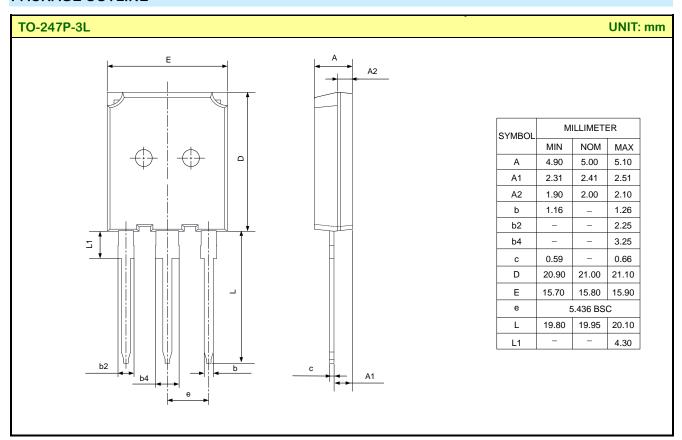
TYPICAL CHARACTERISTICS (CONTINUED)



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PACKAGE OUTLINE





MOS DEVICES OPERATE NOTES:

Electrostatic charges may exist in many things. Please take following preventive measures to prevent effectively the MOS electric circuit as a result of the damage which is caused by discharge:

- The operator must put on wrist strap which should be earthed to against electrostatic.
- Equipment cases should be earthed.
- All tools used during assembly, including soldering tools and solder baths, must be earthed.
- MOS devices should be packed in antistatic/conductive containers for transportation.

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Important notice:

- Silan reserves the right to make changes of this instruction without notice.
- 2. Customers should obtain the latest relevant information when purchasing and should verify whether such information is latest and complete. Please read this instruction and application manual and related materials carefully before using products, including the circuit operation precautions, etc.
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- Product promotion is endless, our company will wholeheartedly provide customers with better products! 8.
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1. First release

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